

TIDA-00762 REV E1 Bill of Materials

| Designator | Quantity | Value | PartNumber | Manufacturer | Description | PackageReference |
|---|----------|-----------|----------------------|-----------------------------|--|-----------------------------------|
| IPC81 | 1 | | TIDA-00762 | Any | Printed Circuit Board | |
| C1, C2, C3, C4 | 4 | 0.1uF | C3216C0G1E104J | TDK | CAP, CERM, 0.1 μ F, 25 V, +/- 5%, C0G/NP0, 1206 | 1206 |
| C5, C7, C8, C10, C11, C19, C20, C22 | 8 | 0.1uF | CGA2B3X7R1H104M050BB | TDK | CAP, CERM, 0.1 μ F, 50 V, +/- 20%, X7R, 0402 | 0402 |
| C6, C14, C17 | 3 | 10uF | C1608X5R1A106M | TDK | CAP, CERM, 10 μ F, 10 V, +/- 20%, X5R, 0603 | 0603 |
| C9 | 1 | 1000pF | C1005X7R1H102K | TDK | CAP, CERM, 1000 pF, 50 V, +/- 10%, X7R, 0402 | 0402 |
| C12 | 1 | 0.022uF | C1005X7R1E223K | TDK | CAP, CERM, 0.022 μ F, 25 V, +/- 10%, X7R, 0402 | 0402 |
| C13 | 1 | 2200pF | C1005X7R1H222K | TDK | CAP, CERM, 2200 pF, 50 V, +/- 10%, X7R, 0402 | 0402 |
| C15 | 1 | 2700pF | GRM155R71H272KA01D | Murata | CAP, CERM, 2700 pF, 50 V, +/- 10%, X7R, 0402 | 0402 |
| C16, C21 | 2 | 2.2uF | C1005X5R1A225K050BC | TDK | CAP, CERM, 2.2 μ F, 10 V, +/- 10%, X5R, 0402 | 0402 |
| C18 | 1 | 0.47uF | C1005X5R1A474K050BB | TDK | CAP, CERM, 0.47 μ F, 10 V, +/- 10%, X5R, 0402 | 0402 |
| D1, D6 | 2 | Green | LTST-C190KGKT | Lite-On | LED, Green, SMD | 1.6x0.8x0.8mm |
| D2, D3 | 2 | 75V | 1N4148X-TP | Micro Commercial Componen | Diode, Switching, 75 V, 0.3 A, SOD-523 | SOD-523 |
| D4 | 1 | Orange | LTST-C190KFKT | Lite-On | LED, Orange, SMD | 1.6x0.8x0.8mm |
| D5 | 1 | Red | LTST-C190CKT | Lite-On | LED, Red, SMD | Red LED, 1.6x0.8x0.8mm |
| H1, H2, H3, H4 | 4 | | 2563 | Voltrex | Mounting Feet, 0.25" tall | |
| J1, J3 | 2 | | PEC02SAAN | Sullins Connector Solutions | Header, 100mil, 2x1, Tin, TH | Header, 2 PIN, 100mil, Tin |
| J2 | 1 | | 105017-0001 | Molex | Receptacle, Micro-USB-B, Right Angle, SMD | Micro USB receptacle |
| L1 | 1 | 6.5uH | 760308101103 | Würth Elektronik | Inductor, 6.5 μ H, 3 A, 0.15 ohm, TH | TH, Dia 30mm, Pin spacing 15mm |
| LBL1 | 1 | | THT-14-423-10 | Brady | Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll | PCB Label 0.650"H x 0.200"W |
| NTC1 | 1 | 10.0k ohm | NTCG163JF103F | TDK | Thermistor NTC, 10.0k ohm, 1%, 0603 | 0603 |
| R1 | 1 | 113k | CRCW0402113KFKED | Vishay-Dale | RES, 113 k, 1%, 0.063 W, 0402 | 0402 |
| R2 | 1 | 7.50k | CRCW04027K50FKED | Vishay-Dale | RES, 7.50 k, 1%, 0.063 W, 0402 | 0402 |
| R3 | 1 | 24.9k | CRCW040224K9FKED | Vishay-Dale | RES, 24.9 k, 1%, 0.063 W, 0402 | 0402 |
| R4, R9, R17, R19 | 4 | 1.00k | CRCW04021K00FKED | Vishay-Dale | RES, 1.00 k, 1%, 0.063 W, 0402 | 0402 |
| R5 | 1 | 80.6k | CRCW040280K6FKED | Vishay-Dale | RES, 80.6 k, 1%, 0.063 W, 0402 | 0402 |
| R6 | 1 | 69.8k | CRCW040269K8FKED | Vishay-Dale | RES, 69.8 k, 1%, 0.063 W, 0402 | 0402 |
| R7, R8, R12, R20, R24 | 5 | 10.0k | CRCW040210K0FKED | Vishay-Dale | RES, 10.0 k, 1%, 0.063 W, 0402 | 0402 |
| R10 | 1 | 499k | CRCW0402499KFKED | Vishay-Dale | RES, 499 k, 1%, 0.063 W, 0402 | 0402 |
| R11 | 1 | 2.00 | CRCW04022R00FKED | Vishay-Dale | RES, 2.00, 1%, 0.063 W, 0402 | 0402 |
| R13 | 1 | 76.8k | CRCW040276K8FKED | Vishay-Dale | RES, 76.8 k, 1%, 0.063 W, 0402 | 0402 |
| R14 | 1 | 10.0k | PCF0402-12-10KBT1 | TT Electronics/IRC | RES, 10.0 k, 0.1%, 0.063 W, 0402 | 0402 |
| R15, R21, R22 | 3 | 100k | CRCW0402100KFKED | Vishay-Dale | RES, 100 k, 1%, 0.063 W, 0402 | 0402 |
| R18 | 1 | 0.02 | RL0603FR-070R02L | Yageo America | RES, 0.02, 1%, 0.1 W, AEC-Q200 Grade 0, 0603 | 0603 |
| R23 | 1 | 200k | CRCW0402200KFKED | Vishay-Dale | RES, 200 k, 1%, 0.063 W, 0402 | 0402 |
| TP6, TP7 | 2 | Black | 5011 | Keystone | Test Point, Multipurpose, Black, TH | Black Multipurpose Testpoint |
| U1 | 1 | | BQ500511RHAR | Texas Instruments | BQ500511RHA, RHA0040A | RHA0040A |

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|------------------|----------|-------|------------------|-------------------|--|------------------|
| U2 | 1 | | BQ50002RHB | Texas Instruments | 4.2V to 5.5V Input, 3A Full Bridge, 2 Channel Analog Demodulation Wireless Power TX-Driver for Wireless Charging Applications, RHB0032E | RHB0032E |
| FID1, FID2, FID3 | 0 | | N/A | N/A | Fiducial mark. There is nothing to buy or mount. | Fiducial |
| R16 | 0 | 10.0k | CRCW040210K0FKED | Vishay-Dale | RES, 10.0 k, 1%, 0.063 W, 0402 | 0402 |

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